TXC TXC CORPORATION

SPECIFICATION FOR APPROVAL

CUSTOMER	:	
PRODUCT TYPE		Oven-Controlled Crystal Oscillator (OCXO)
NOMINAL FREQ.		19.44MHz
TXC P/N		OH19470001
REVISION		S3
CUSTOMER P/N		
PM / SALES		Paul Chen
DATE		1-Mar-22
CUSTOMER CONFIRMATION	•	(Signature)
		(Date)

- (1) TXC requires one copy returned with signature and title of authorized individual that signifies acceptance of the attached specifications.
- (2) Orders received and accepted by TXC after return of signed copy of specification will be produced per these specifications.
- (3) Any changes to these specifications must be agreed upon by both parties and new revision of the Product Specification Sheet will be issued.
- (4) Any issuance of purchase order prior to consigning back the Approval page of "Specification Sheets" from customers will be regarded as the agreement on the contents of these specifications.

RoHS Compliant

(for glass crystal only : Pb used in sealing glass material is exempt from EU directive)

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PRODUCT TYPE

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NOMINAL FREQ.

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19.44MHz

REVISION

PE/RD	QA	MFG
Win Lin Heich		
Wan-Lin Hsieh		
1-Mar-22		

NOTE:

- (1) The green product standard set by TXC is based upon the international standards. Related information is publicly described on the TXC's Website, and updated regularly. The document is compliant with the latest green product quality system directives at the time.
- (2) Revision "Sx" is for engineering samples only. PE/RD's approval required.
- (3) Revision "Ax" is production ready. PE, QA and MFG's approval required.

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TXC P/N: OH19470001 REVISION: S3 PAGE: 1

<u>Rev</u>	<u>Revise page</u>	Revise contents	<u>Date</u>	<u>Ref.No.</u>	<u>Reviser</u>	
S1	N/A	Initial released	17-Feb-21	N/A	Vins Wang	
	2	Item 27 Allan deviation Change Typ. 7.0 to 2.0 Add Max. 7.0				
S2	3	Add Note 2	1-Mar-22	N/A	S.Chang	
	6	Add Note 3				
S3	5	Tape reel dimension change	22-Apr-22	N/A	Vins Wang	



■ ELECTRICAL SPECIFICATIONS (Note1)

Item Par		rameters	Maggurament Condition	Electrical Specifications			
		rumeters	Measurement Condition	MIN	ТҮР	MAX	UNITS
1	Nominal frequency				19.44		MHz
2	Supply voltage (Vcc)		±5%	3.135	3.3	3.465	V
3	Current	During warm up	Ambient temperature at 25 °C			750	mА
4	consumption	At steady state	Ambient temperature at 25°C			200	mА
5	5 Warm-up time		Time needed for frequency to be within ±25 ppb reference to frequency after 1 hour, at 25°C.		1		minute
6	Initial frequency	accuracy	At time of shipment, reference to nominal frequency, at 25°C ±2°C	-500		500	ppb
7	Reflow shift		After 1 hour recovery at 25°C	-0.5		0.5	ррт
8	Operating tempe	erature range		-40		85	°C
9	Frequency stability	vs. temperature (in still air)	Within operating temperature range, reference to (Fmax+Fmin)/2	-50		50	ppb
10		vs. Vcc variation	Vcc variation ±5%, reference to frequency at Vcc=3.3V		±10		ppb
11		vs. load variation	Load variation ±5%, reference to frequency at load= 15pF		±10		ppb
12 Frequency slope (in still air)		(in still air)	Temperature ramping rate 1° C/minute max.		±0.1	<u>±3</u>	ppb/°C
13	Output load			15		рF	
14		Output type			LVCMOS	5	NA
15		High level (VOH)		90% Vcc			V
16	Output	Low level (VOL)				10% Vcc	V
17	waveform	Duty cycle		45		55	%
18		Rise time				2	ns
19		Fall time				2	ns
20		At 1Hz offset			-77		dBc/Hz
21		At 10Hz offset			-109		dBc/Hz
22		At 100Hz offset			-132		dBc/Hz
23	phase noise	At 1kHz offset	Ambient temperature at 25°C		-147		dBc/Hz
24		At 10kHz offset			-155		dBc/Hz
25		At 100kHz offset			-158		dBc/Hz
26		At 1MHz offset			-159		dBc/Hz
27	Allan deviation	Tau=1.0s	Ambient temperature at 25°C		7.0		e-11
28		Daily			±3		ppb/da
29	Aging	1st year	After 30 days of operation			±1	ppm/y
30		10 years				±2	ppm/10y

SPECIFICATIONS NOTES

Note 1 The frequency specifications apply after 48 hours of contiuous operation after soldering and assembly based on nominal conditions.



FMT-DOC024



Month

(Note) Tracking Code = Lot (L) + Year (Y) + Month (m) + Lot Serial Number (nn)

Year

icui				
2017	2018	2019	2020	2021
Α	В	С	D	E
2022	2023	2024	2025	2026
F	G	Н	J	К
2027	2028	2029	2030	2031
м	N	Р	Q	R
2032	2033	2034	2035	2036
S	Т	U	V	W

APR JAN FEB MAR MAY JUN f b d а с e JUL AUG SEP OCT NOV DEC g h j k m n

RECOMMENDED PAD LAYOUT



(Dimension unit : mm)

- (1) Recommended exclusion area in any copper plane to isolate the OCXO from the underlying ground or power planes to reduce thermal loss.
- (2) To further minimize the thermal loss, it is also recommended that the trace connecting to the pads should not connect to any layer inside the exclusion area.
- (3) For the same reason, it is recommended to preserve the exclusion area larger than the product size of 2mm in both of length and width.

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is ±0.1mm

Standard Reel Quantity is 500 pcs per reel

- 2. Pocket position relative to sprocket hole measured as true position of pocket not pocket hole.
- 3. Ao & Bo measured on a place 0.3mm above the bottom of the pocket to top surface of the carrier.
- 4. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
- 5. Carrier camber shall be not than 1mm per 100mm through a length of 250mm.



Note 3 In case of the manual soldering, please do not apply the excess heat source to the plastic cover of device. The plastic cover may be damaged when the excess temperature is over 270°C within a period of time.